SN54ABT16652, SN74ABT16652
16-BIT BUS TRANSCEIVERS AND REGISTERS
WITH 3-STATE OUTPUTS

- Members of the Texas Instruments *Widebus*™ Family

- State-of-the-Art *EPIC*-II*B*™ BiCMOS Design Significantly Reduces Power Dissipation

- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17

- Typical V_{OLP} (Output Ground Bounce) < 1 V at V_{CC} = 5 V, T_A = 25°C

- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise

- Flow-Through Architecture Optimizes PCB Layout

- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})

- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Package and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54ABT16652 . . . WD PACKAGE
SN74ABT16652 . . . DL PACKAGE
(TOP VIEW)

1OEAB	1 56	1$\overline{OEBA}$
1CLKAB	2 55	1CLKBA
1SAB	3 54	1SBA
GND	4 53	GND
1A1	5 52	1B1
1A2	6 51	1B2
V_{CC}	7 50	V_{CC}
1A3	8 49	1B3
1A4	9 48	1B4
1A5	10 47	1B5
GND	11 46	GND
1A6	12 45	1B6
1A7	13 44	1B7
1A8	14 43	1B8
2A1	15 42	2B1
2A2	16 41	2B2
2A3	17 40	2B3
GND	18 39	GND
2A4	19 38	2B4
2A5	20 37	2B5
2A6	21 36	2B6
V_{CC}	22 35	V_{CC}
2A7	23 34	2B7
2A8	24 33	2B8
GND	25 32	GND
2SAB	26 31	2SBA
2CLKAB	27 30	2CLKBA
2OEAB	28 29	2$\overline{OEBA}$

description

The 'ABT16652 are 16-bit bus transceivers that consist of D-type flip-flops and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. These devices can be used as two 8-bit transceivers or one 16-bit transceiver.

Output-enable (OEAB and $\overline{OEBA}$) inputs are provided to control the transceiver functions. Select-control (SAB and SBA) inputs are provided to select whether real-time or stored data is transferred. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. A low input selects real-time data, and a high input selects stored data. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'ABT16652.

Data on the A- or B-data bus, or both, can be stored in the internal D-type flip-flops by low-to-high transitions at the appropriate clock (CLKAB or CLKBA) inputs regardless of the select- or enable-control inputs. When SAB and SBA are in the real-time transfer mode, it is possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and $\overline{OEBA}$. In this configuration, each output reinforces its input. When all other data sources to the two sets of bus lines are at high impedance, each set of bus lines remains at its last state.

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description (continued)

To ensure the high-impedance state during power up or power down, $\overline{OEBA}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver (B to A). OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver (A to B).

The SN54ABT16652 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16652 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE

INPUTS						DATA I/O[†]		OPERATION OR FUNCTION
OEAB	$\overline{OEBA}$	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
L	H	H or L	H or L	X	X	Input	Input	Isolation
L	H	↑	↑	X	X	Input	Input	Store A and B data
X	H	↑	H or L	X	X	Input	Unspecified[‡]	Store A, hold B
H	H	↑	↑	X[‡]	X	Input	Output	Store A in both registers
L	X	H or L	↑	X	X	Unspecified[‡]	Input	Hold A, store B
L	L	↑	↑	X	X[‡]	Output	Input	Store B in both registers
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
H	H	X	X	L	X	Input	Output	Real-time A data to B bus
H	H	H or L	X	H	X	Input	Output	Stored A data to B bus
H	L	H or L	H or L	H	H	Output	Output	Stored A data to B bus and stored B data to A bus

[†] The data-output functions may be enabled or disabled by a variety of level combinations at OEAB or $\overline{OEBA}$. Data-input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

[‡] Select control = L; clocks can occur simultaneously.
Select control = H; clocks must be staggered to load both registers.

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OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
L	L	X	X	X	L

REAL-TIME TRANSFER
BUS B TO BUS A

OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
H	H	X	X	L	X

REAL-TIME TRANSFER
BUS A TO BUS B

OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
X	H	↑	X	X	X
L	X	X	↑	X	X
L	H	↑	↑	X	X

STORAGE FROM
A, B, OR A AND B

OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
H	L	H or L	H or L	H	H

TRANSFER STORED DATA
TO A AND/OR B
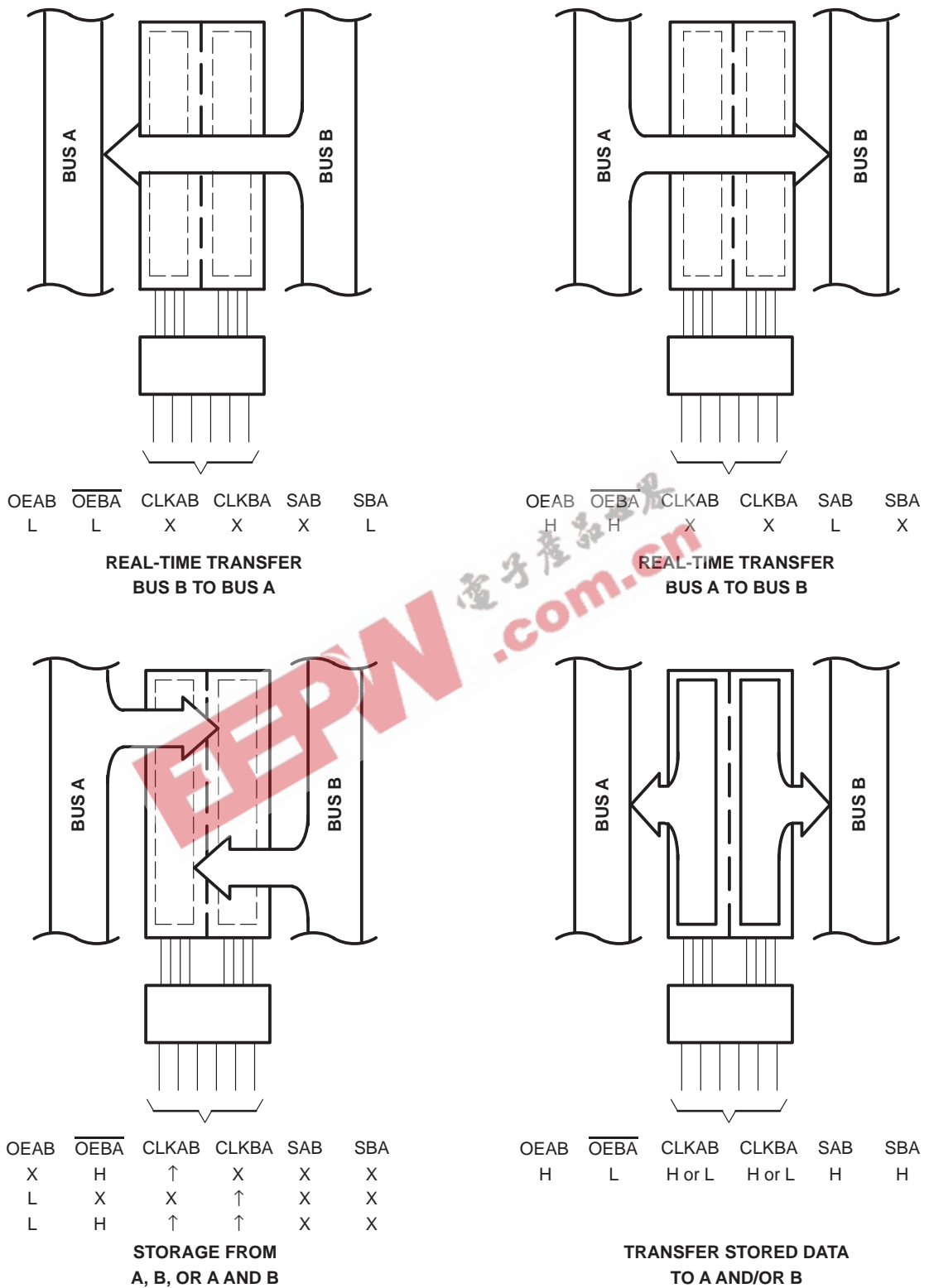
Figure 1. Bus-Management Functions
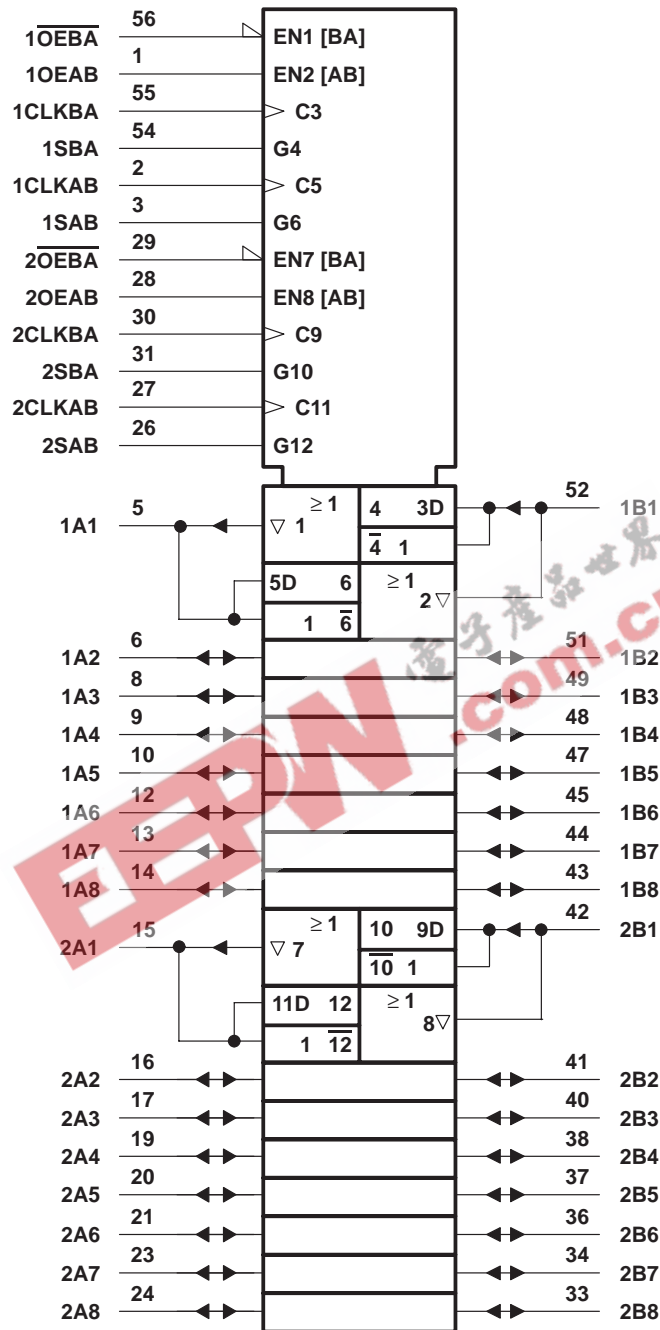
logic symbol†

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)
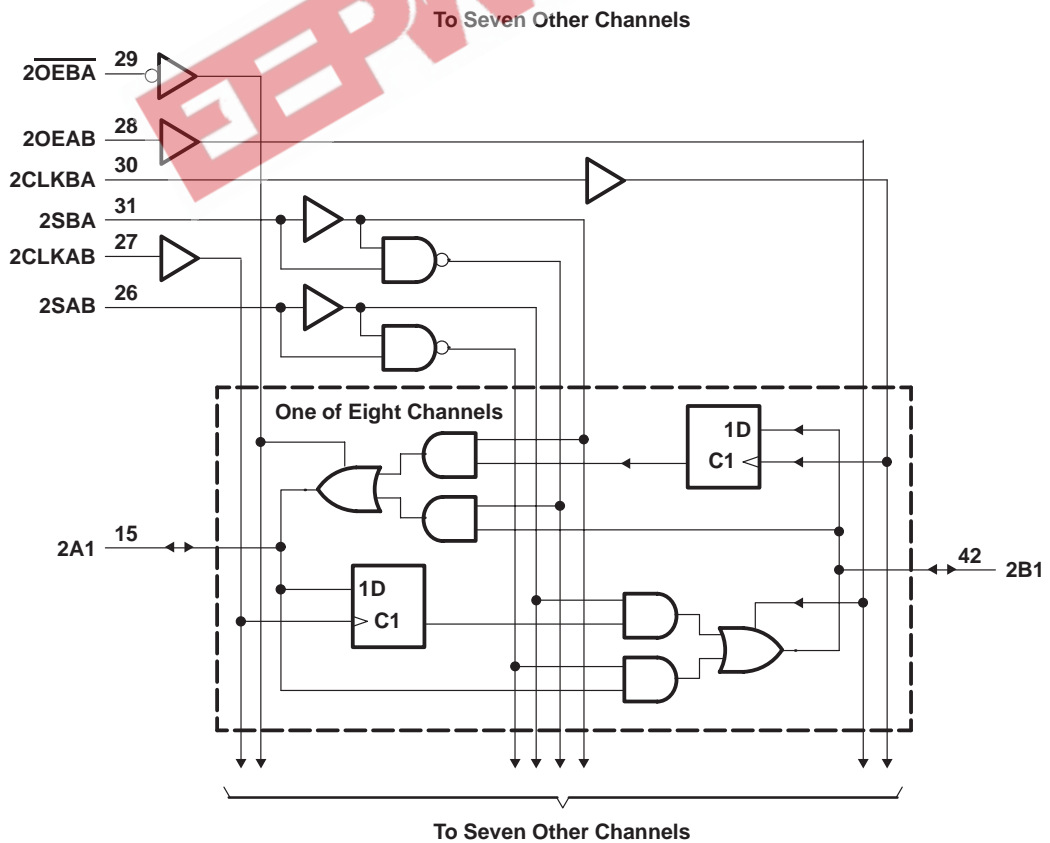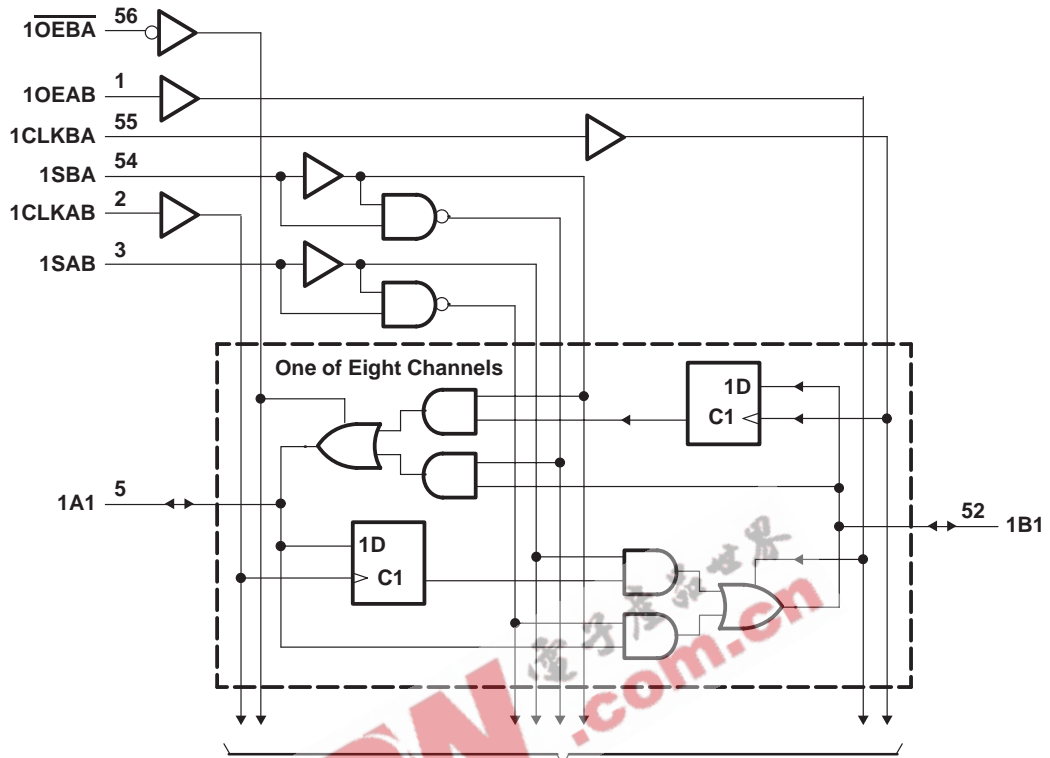
To Seven Other Channels

To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	....	–0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	....	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V_O	....	–0.5 V to 5.5 V
Current into any output in the low state, I_O: SN54ABT16652	....	96 mA
SN74ABT16652	....	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	....	–18 mA
Output clamp current, I_{OK} ($V_O < 0$)	....	–50 mA
Package thermal impedance, θ_{JA} (see Note 2): DL package	....	74°C/W
Storage temperature range, T_{stg}	....	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

recommended operating conditions (see Note 3)

			SN54ABT16652		SN74ABT16652		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current			–24		–32	mA
I_{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		$T_A = 25°C$ MIN	TYP†	MAX	SN54ABT16652 MIN	MAX	SN74ABT16652 MIN	MAX	UNIT
V_{IK}		$V_{CC} = 4.5$ V,	$I_I = -18$ mA			−1.2		−1.2		−1.2	V
V_{OH}		$V_{CC} = 4.5$ V,	$I_{OH} = -3$ mA	2.5			2.5		2.5		V
		$V_{CC} = 5$ V,	$I_{OH} = -3$ mA	3			3		3		
		$V_{CC} = 4.5$ V	$I_{OH} = -24$ mA	2			2				
			$I_{OH} = -32$ mA	2*					2		
V_{OL}		$V_{CC} = 4.5$ V	$I_{OL} = 48$ mA			0.55		0.55			V
			$I_{OL} = 64$ mA			0.55*				0.55	
V_{hys}					100						mV
I_I	Control inputs	$V_{CC} = 5.5$ V, $V_I = V_{CC}$ or GND				±1		±1		±1	µA
	A or B ports					±20		±20		±20	
I_{OZH}‡		$V_{CC} = 5.5$ V,	$V_O = 2.7$ V			10		10		10	µA
I_{OZL}‡		$V_{CC} = 5.5$ V,	$V_O = 0.5$ V			−10		−10		−10	µA
I_{off}		$V_{CC} = 0$,	V_I or $V_O ≤ 4.5$ V			±100				±100	µA
I_{CEX}		$V_{CC} = 5.5$ V, $V_O = 5.5$ V	Outputs high			50		50		50	µA
I_O§		$V_{CC} = 5.5$ V,	$V_O = 2.5$ V	−50	−100	−180	−50	−180	−50	−180	mA
I_{CC}	A or B ports	$V_{CC} = 5.5$ V, $I_O = 0$, $V_I = V_{CC}$ or GND	Outputs high			2		2		2	mA
			Outputs low			32		32		32	
			Outputs disabled			2		2		2	
ΔI_{CC}¶	Data inputs	$V_{CC} = 5.5$ V, One input at 3.4 V, Other inputs at V_{CC} or GND	Outputs enabled			50		50		50	µA
			Outputs disabled			50		50		50	
	Control inputs	$V_{CC} = 5.5$ V, One input at 3.4 V, Other inputs at V_{CC} or GND				50		50		50	
C_i	Control inputs	$V_I = 2.5$ V or 0.5 V			4						pF
C_{io}	A or B ports	$V_O = 2.5$ V or 0.5 V			8						pF

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at $V_{CC} = 5$ V.

‡ The parameters I_{OZH} and I_{OZL} include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

|		SN54ABT16652				UNIT
		V_{CC} = 5 V, T_A = 25°C		MIN	MAX	
		MIN	MAX			
f_{clock}	Clock frequency	0	125	0	125	MHz
t_w	Pulse duration, CLK high or low	4.3		4.3		ns
t_{su}	Setup time, A or B before CLKAB↑ or CLKBA↑	3.5		4		ns
t_h	Hold time, A or B after CLKAB↑ or CLKBA↑	0.5		0.5		ns

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)

		SN74ABT16652				UNIT
		V_{CC} = 5 V, T_A = 25°C		MIN	MAX	
		MIN	MAX			
f_{clock}	Clock frequency	0	125	0	125	MHz
t_w	Pulse duration, CLK high or low	4.3		4.3		ns
t_{su}	Setup time, A or B before CLKAB↑ or CLKBA↑	3		3		ns
t_h	Hold time, A or B after CLKAB↑ or CLKBA↑	0		0		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT16652					UNIT
			V_{CC} = 5 V, T_A = 25°C			MIN	MAX	
			MIN	TYP	MAX			
f_{max}			125			125		MHz
t_{PLH}	CLK	B or A	1.5	3.1	4	1	5	ns
t_{PHL}			1.5	3.2	4.1	1	5	
t_{PLH}	A or B	B or A	1	2.3	3.2	0.6	4	ns
t_{PHL}			1	3	4.1	0.6	4.9	
t_{PLH}	SAB or SBA†	B or A	1	2.9	4.3	0.6	5.3	ns
t_{PHL}			1	3.1	4.6	0.6	5.3	
t_{PZH}	$\overline{OEBA}$	A	1	2.8	4.1	0.6	5.2	ns
t_{PZL}			1.5	3.1	4.4	1	5.4	
t_{PHZ}	$\overline{OEBA}$	A	1.5	3.4	4.7	0.8	5.3	ns
t_{PLZ}			1.5	2.7	4	1	5.3	
t_{PZH}	OEAB	B	1	2.6	3.6	0.8	4.7	ns
t_{PZL}			1.5	2.8	4.5	1	5	
t_{PHZ}	OEAB	B	2	4.2	5.9	1	6.4	ns
t_{PLZ}			1.5	3.4	4.9	1	5.9	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT16652					UNIT
			V_{CC} = 5 V, T_A = 25°C			MIN	MAX	
			MIN	TYP	MAX			
f_{max}			125			125		MHz
t_{PLH}	CLK	B or A	1.5	3.1	4	1.5	4.9	ns
t_{PHL}			1.5	3.2	4.1	1.5	4.7	
t_{PLH}	A or B	B or A	1	2.3	3.2	1	3.9	ns
t_{PHL}			1	3	4.1	1	4.6	
t_{PLH}	SAB or SBA†	B or A	1	2.9	4.3	1	5	ns
t_{PHL}			1	3.1	4.3	1	5	
t_{PZH}	$\overline{OEBA}$	A	1	2.8	4.1	1	5	ns
t_{PZL}			1.5	3.1	4.4	1.5	5.3	
t_{PHZ}	$\overline{OEBA}$	A	1.5	3.4	4.4	1.5	4.9	ns
t_{PLZ}			1.5	2.7	3.6	1.5	4	
t_{PZH}	OEAB	B	1	2.6	3.6	1	4.2	ns
t_{PZL}			1.5	2.8	3.9	1.5	4.6	
t_{PHZ}	OEAB	B	2	4.2	5.5	2	5.9	ns
t_{PLZ}			1.5	3.4	4.5	1.5	5.2	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

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PARAMETER MEASUREMENT INFORMATION
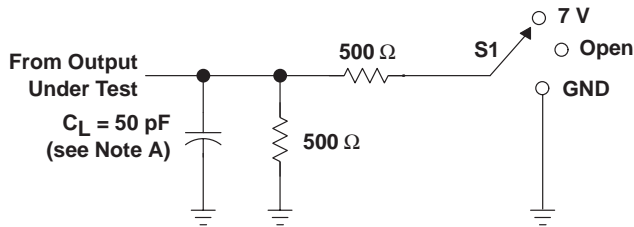
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open

LOAD CIRCUIT

VOLTAGE WAVEFORMS
PULSE DURATION
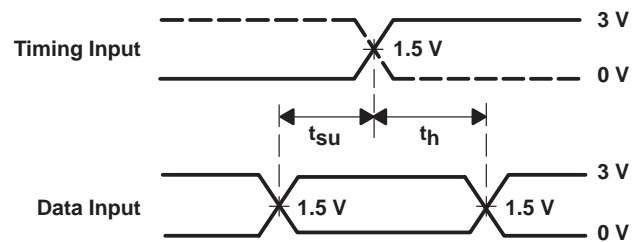
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES
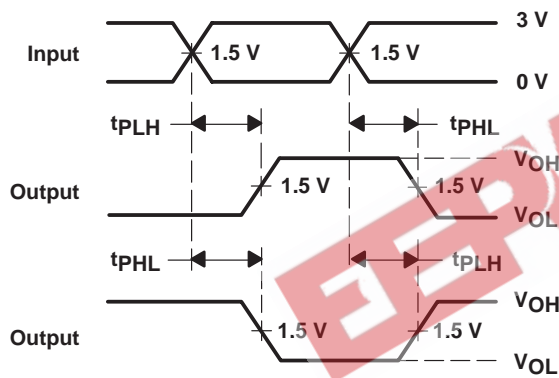
VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS
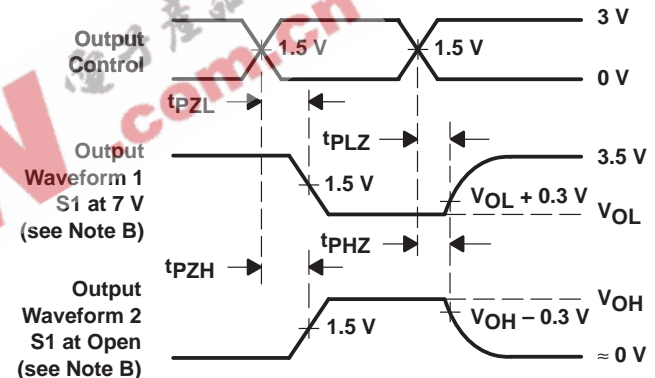
VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
5962-9584101QXA	ACTIVE	CFP	WD	56	1	TBD	A42 SNPB	N / A for Pkg Type
SN74ABT16652DL	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16652DLG4	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16652DLR	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16652DLRG4	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54ABT16652WD	ACTIVE	CFP	WD	56	1	TBD	A42 SNPB	N / A for Pkg Type

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL BOX INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers
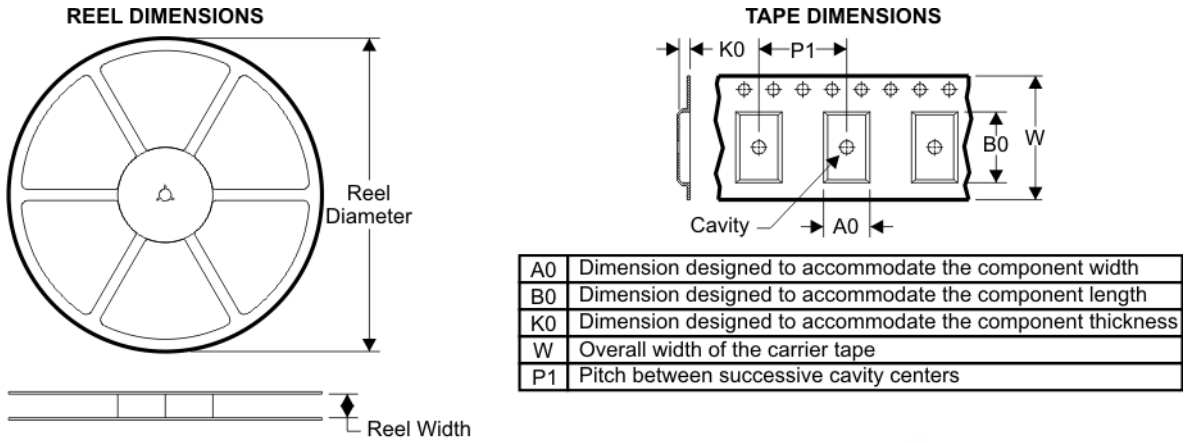
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE
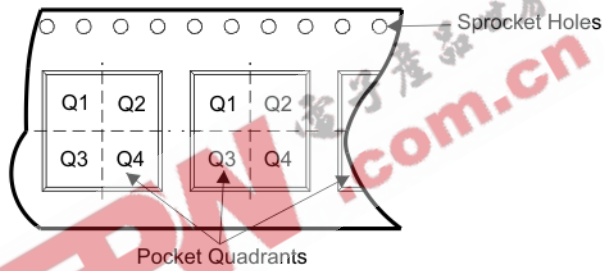
Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16652DLR	DL	56	SITE 41	330	32	11.35	18.67	3.1	16	32	Q1

TAPE AND REEL BOX DIMENSIONS
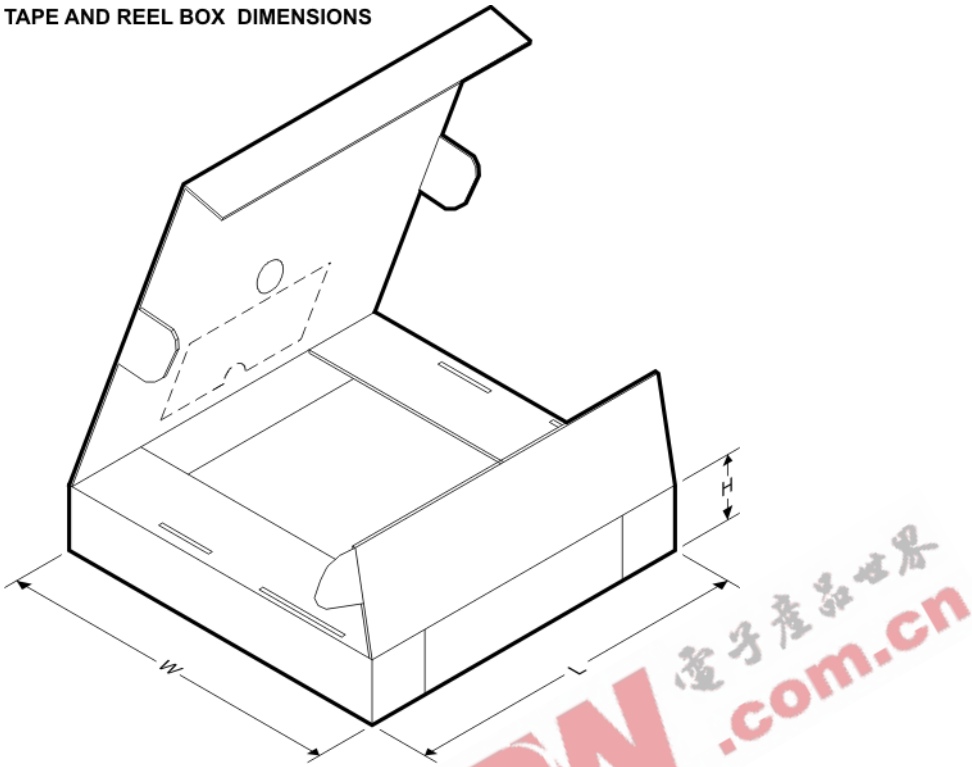
Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74ABT16652DLR	DL	56	SITE 41	346.0	346.0	49.0

WD (R-GDFP-F**)   **CERAMIC DUAL FLATPACK**

48 LEADS SHOWN
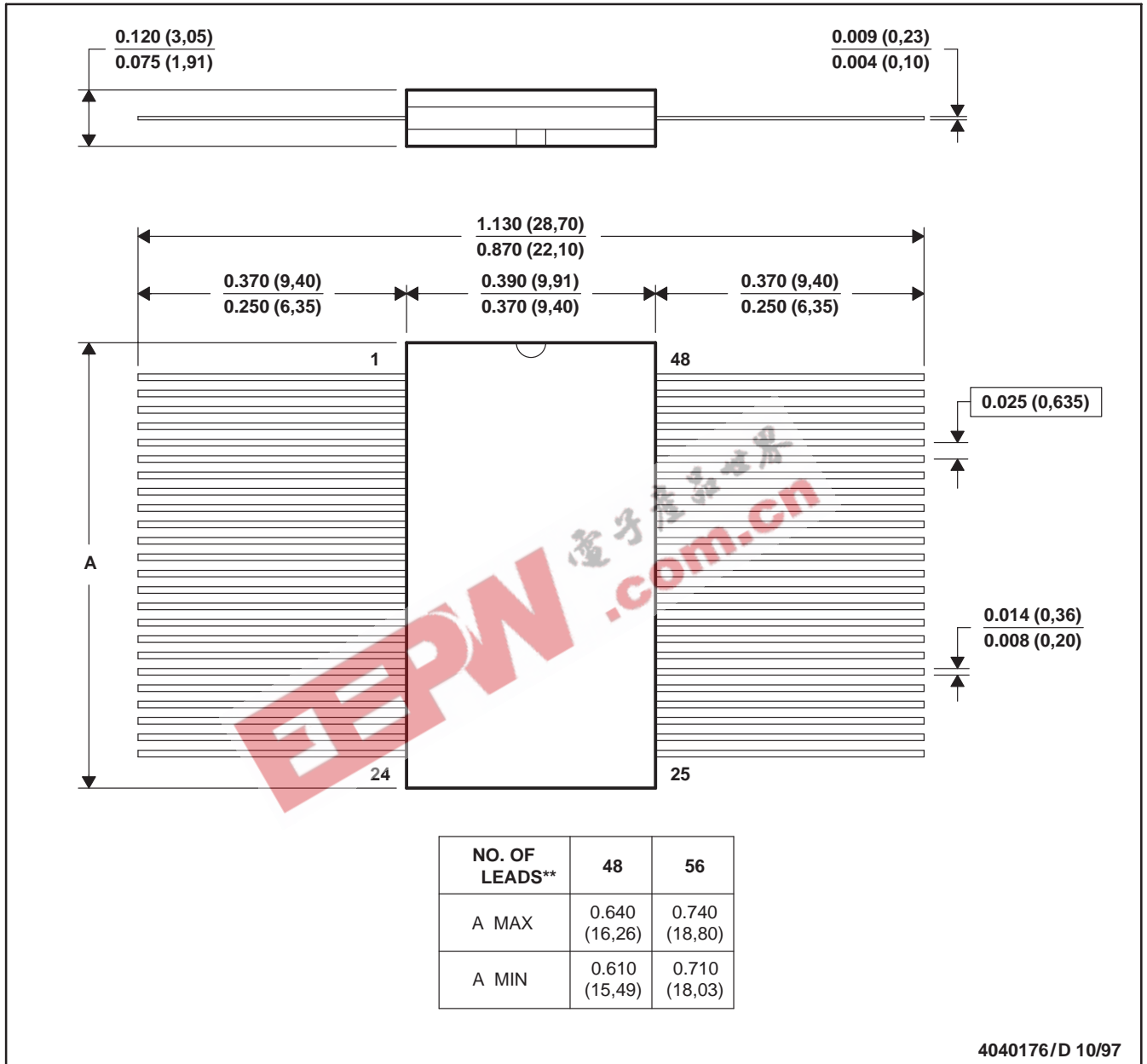
Dimensions shown on drawing:

- 0.120 (3,05) / 0.075 (1,91)
- 0.009 (0,23) / 0.004 (0,10)
- 1.130 (28,70) / 0.870 (22,10)
- 0.370 (9,40) / 0.250 (6,35)
- 0.390 (9,91) / 0.370 (9,40)
- 0.370 (9,40) / 0.250 (6,35)
- 0.025 (0,635)
- 0.014 (0,36) / 0.008 (0,20)

Pin references: 1, 48, 24, 25

NO. OF LEADS**	48	56
A MAX	0.640 (16,26)	0.740 (18,80)
A MIN	0.610 (15,49)	0.710 (18,03)

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NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only
E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA
GDFP1-F56 and JEDEC MO-146AB

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DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN
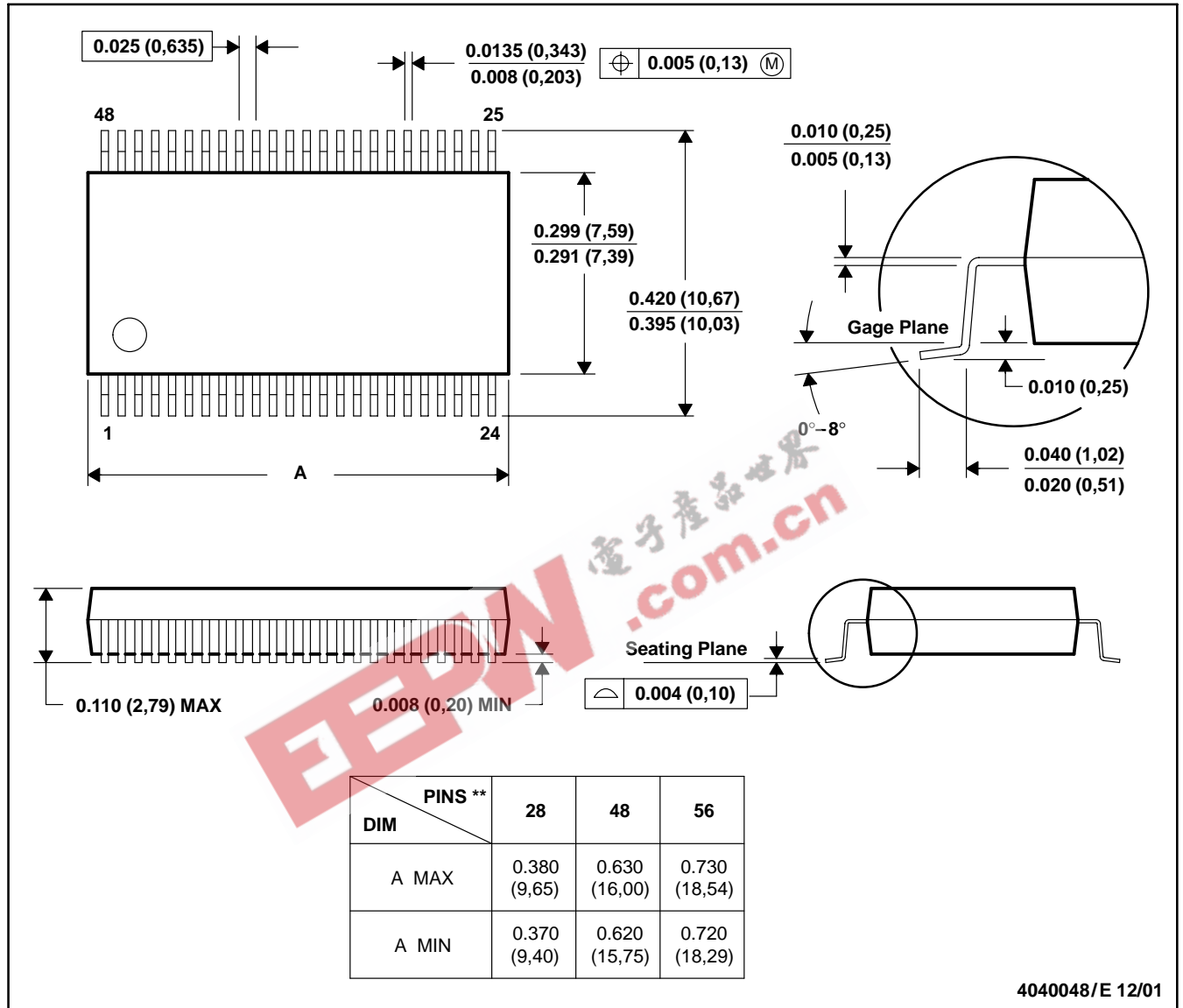
0.025 (0,635)

$\dfrac{0.0135\ (0,343)}{0.008\ (0,203)}$ ⊕ 0.005 (0,13) Ⓜ

48   25

$\dfrac{0.010\ (0,25)}{0.005\ (0,13)}$

$\dfrac{0.299\ (7,59)}{0.291\ (7,39)}$

$\dfrac{0.420\ (10,67)}{0.395\ (10,03)}$

Gage Plane

0.010 (0,25)

1   24

0°–8°

$\dfrac{0.040\ (1,02)}{0.020\ (0,51)}$

A

0.110 (2,79) MAX   0.008 (0,20) MIN

Seating Plane

△ 0.004 (0,10)

	PINS **		
DIM	28	48	56
A MAX	0.380 (9,65)	0.630 (16,00)	0.730 (18,54)
A MIN	0.370 (9,40)	0.620 (15,75)	0.720 (18,29)

4040048 / E 12/01

NOTES: A. All linear dimensions are in inches (millimeters).
   B. This drawing is subject to change without notice.
   C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
   D. Falls within JEDEC MO-118

TEXAS INSTRUMENTS

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IMPORTANT NOTICE